IN THE UNITED STA S PATENT AND TRADEMARK OFFICE

Applicants:

KONDO et al

10/061,435

Docket No:

20206-123(P99-2890)

Serial No:

Group Art Unit:

2181

Filing Date:

January 31, 2

Examiner:

N/A

For:

"System Recover rrors for Processor and Associated Components"

Commissioner for Patents Washington, D.C. 20231

RECEIVED

TRANSMITTAL

JUL 0 1 2002

Transmitted herewith are the following documents: \boxtimes

Technology Center 2100

Letter for Application Data Sheet (1 page); Ø

冈 Application Data Sheet (2 pages);

Postcard for date-stamped return as confirmation of receipt of these materials. Ø

X The Commissioner is authorized to charge any required fees, or credit any overpayment to Deposit Account No. 02-3964.

Date: June 18, 2002

Leah Sherry Reg. No. 43,918

OPPENHEIMER WOLFF & DONNELLY LLP

CUSTOMER NUMBER 25696 P.O. Box 10356 Palo Alto, CA 94303 650.320.4000

CERTIFICATE OF MAILING under 37 CFR 1.8

I hereby certify that this paper along with any papers referred to as being attached or enclosed is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C., 20231.

Date: June 18, 2002

UNITED SÆ EMARK OFFICE

Applicant(s): KONDO et al

Application No.: 10/061,43

Filing Date: January 31, 2002

"System Recovery from Errors for Processor and Associated Components"

Examiner:

N/A

Art Unit:

Sir:

2181

Docket No.:

20206-123 (P99-2890)

CERTIFICATE OF MAILING

I hereby certify that, on the date shown below. this piece of correspondence and its associated papers are being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231.

Bv:

Date: June

Commissioner for Patents Washington, DC 20231

JUL 0 1 2002

Technology Center 2100

The enclosed Application Data Sheet is being submitted for the above-identified application in order to update the U.S. Patent Office records with the residence address for inventor, William P. Bunton. Mr. Bunton's address has changed from his residence address listed on the Declaration and Power of Attorney to the residence address listed on the enclosed Application Data Sheet. No other inventor has changed their residence address.

LETTER FOR APPLICATION DATA SHEET

The Applicants respectfully request the U.S. Patent Office to enter the information contained on the Application Data Sheet to bring current the inventor's address for the pending application.

Dated: June | 2002

OPPENHEIMER WOLFF & DONNELLY LLP

CUSTOMER NO. 25696

P.O. Box 10356 Palo Alto, CA 94303 Tel: 650/320-4000

Fax: 650/320-4100

Respectfully submitted,

Leah Sherry

Reg. No. 43,918